

KLT-U1MF-OV5640-1B V2.0

**5MP OmniVision OV5640-1B MIPI-Schnittstelle M12
Fester Fokus Kameramodul**



Vorderansicht



Rückansicht

Spezifikationen

Kameramodul Nr.	KLT-U1MF-OV5640-1B V2.0
Auflösung	5MP
Bildsensor	OV5640-1B
Sensorart	1/4"
Pixel Größe	1.4 um x 1.4 um
EFL	0.90 mm
F.NO	2.00
Pixel	2592 x 1944
Betrachtungswinkel	220.0°(DFOV) 187.0°(HFOV) 144.0°(VFOV)
Linsenabmessungen	13.00 x 13.00 x 13.56 mm
Modulgröße	65.00 x 22.00 mm
Modultyp	Fester Fokus
Schnittstelle	MIPI
Autofokus-VCM-Treiber-IC	Eingebettet
Linsenmodell	KLT-LENS-TRC-F5022A6-02
Linsentyp	650 nm IR-Schnitt
Betriebstemperatur	-30°C to +70°C
Gegenstecker	AXK724147G

KLT-U1MF-OV5640-1B V2.0

**5MP OmniVision OV5640-1B MIPI-Schnittstelle M12
Fester Fokus Kameramodul**



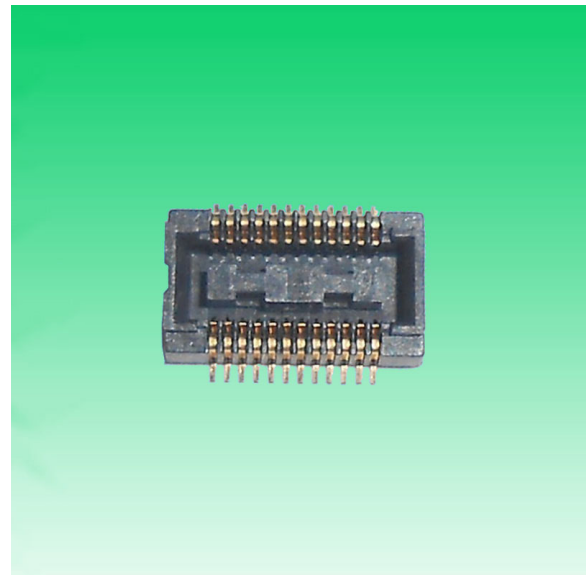
Ansicht von oben



Seitenansicht

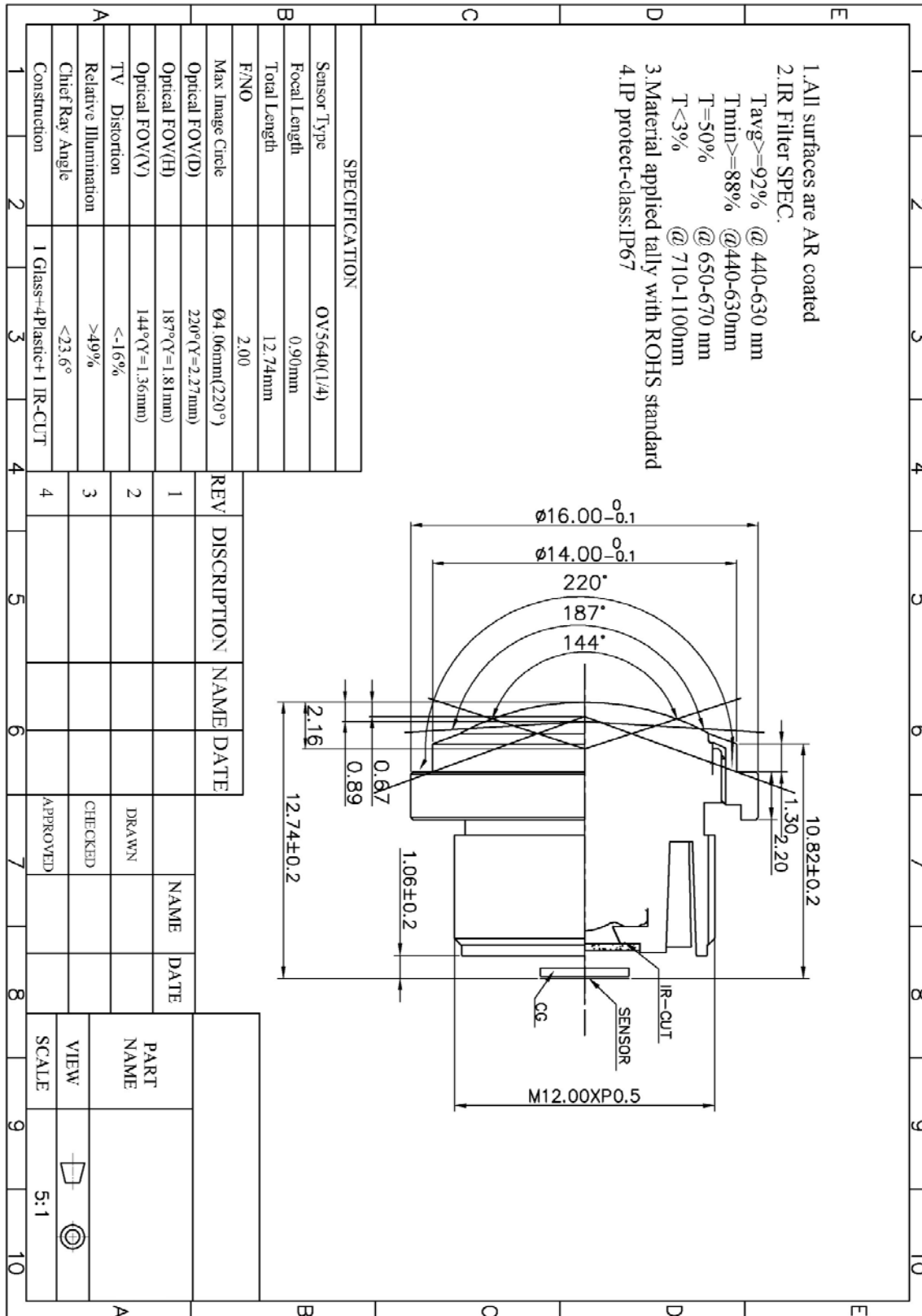


Untersicht



Gegenstecker

Lens Model: KLT-LENS-TRC-F5022A6-02



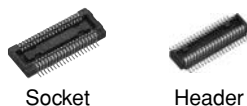
Panasonic
ideas for life

NARROW-PITCH CONNECTORS FOR BOARD-TO-BOARD AND BOARD-TO-FPC CONNECTION

NARROW PITCH (0.4mm) CONNECTORS P4 SERIES



• Without retention fitting



• With retention fitting

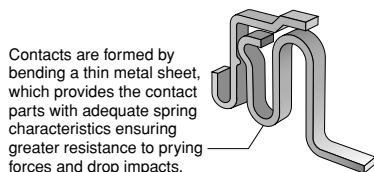


FEATURES

1. 0.4 mm pitch and support for mated heights of up to 1.5 mm, 2.0 mm, 2.5 mm, 3.0 mm, 3.5 mm, and 4.0 mm.

2. Strong resistance to adverse environments! Utilizes **TOUGH CONTACT** construction for high contact reliability.

1) Contacts are highly resistant to shock caused by dropping and employ our original bellows contact construction.

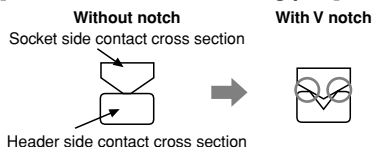


2) V notch construction used for excellent resistance against foreign matters.

● What is V notch construction?

By using the edge for the contacting part and increasing contact pressure per unit area, the effectiveness in removing flux and contaminants is increased compared to its predecessor. This is also effective in preventing the trapping of contaminants.

[Cross section of contacting part]

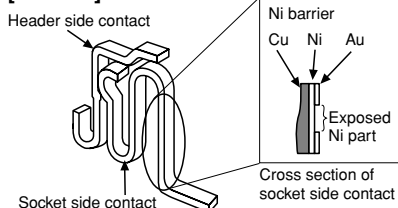


3) Use of Ni barrier construction is standard. Highly effective against solder creeping.

● What is Ni barrier construction?

By providing an exposed nickel part on the gold (Au) plated contact, solder creeping is prevented despite the ultra low profile.

[Contact]

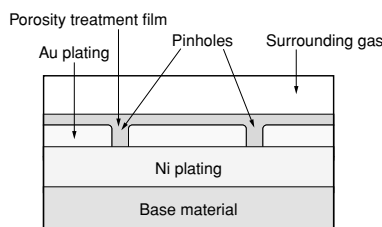


Note: Construction makes solder creeping difficult because header side is formed at the same time.

4) Porosity treatment applied for improved resistance against corrosion.

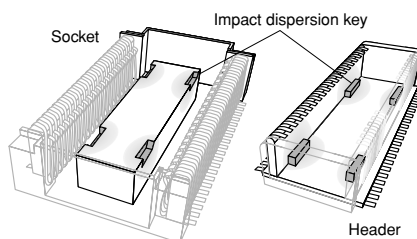
What is porosity treatment?

This treatment consists of coating the surface with a very thin film to seal pinholes in the gold plating. This porosity treatment technology ensures the same contact reliability for thin gold plating as that of thick gold plating.



- Improvement in insertion/removal durability
- Improvement in resistance to corrosion
- Improvement in contact reliability for digital signals

3. It is constructed with impact dispersion keys inside the body to disperse shocks when dropped.



A high level of shock resistance is ensured by dispersing impact over the four locations where the socket indentations and header protrusions are mated together.

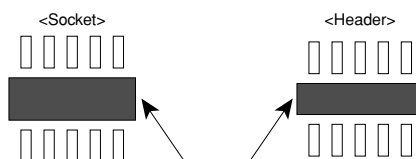
Note: The following numbers of contacts are not supported due to suction surface factors.

• Without retention fitting: 18 contacts or less

• With retention fitting: 22 contacts or less

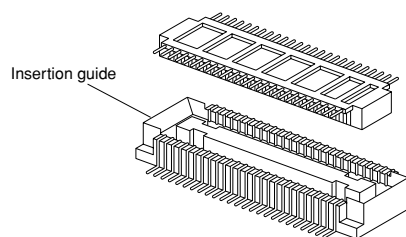
4. Construction makes designing devices easier.

1) The lower connector bottom surface construction prevents contact and shorts between the PCB and metal terminals. This enables freedom in pattern wiring, helping to make PCB's smaller.



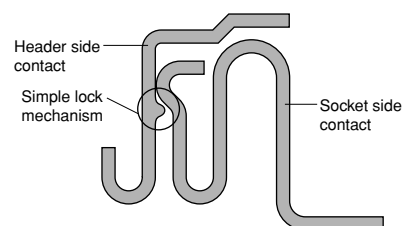
Connector bottom: Create any thru-hole and pattern wiring.

2) Guides are provided to take up any position shift and facilitate insertion.



3) The connector has a simple lock mechanism.

Superior mated operation with click feel to indicate that mated is complete.



5. Design makes efficient mounting.

Features a terminal flatness of 0.08 mm, construction resistant to creeping flux, and design that facilitates visual inspection of the soldered part.

6. Compliance with RoHS Directive

Environmentally friendly, the connectors comply with Europe's RoHS Directive. Cadmium, lead, mercury, hexavalent chromium, PBB and PBDE are not used.

7. Connectors for inspection available

Connectors for inspection are available that are ideal for modular unit inspection and inspection in device assembly processes.

APPLICATIONS

Compact portable devices “Cellular phones, DVC, Digital cameras, etc”

Ideal for Board-to-FPC connections

Before mating

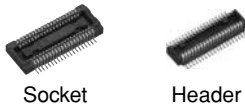
After mating

The simple lock mechanism ensures that the connector clicks into position when it is inserted for reliable single-action insertion on the PCB.

This enables the number of pins to be doubled while the size remains the same as that for existing FPC connectors. This, in turn, contributes to making products and equipment more compact.

TABLE OF PRODUCT TYPES

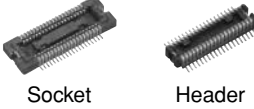
P4 (0.4 mm pitch): Without retention fitting



☆: Available for sale

Mated height		1.5mm	2.0mm	2.5mm	3.0mm	3.5mm	4.0mm
Number of contacts	14	☆	☆	☆			
	16	☆					
	20	☆	☆	☆			
	22	☆					
	24	☆	☆	☆			
	26	☆	☆				
	28	☆					
	30	☆	☆	☆			
	34	☆	☆				
	36	☆					
	40	☆	☆	☆			
	44	☆		☆			
	50	☆	☆	☆			
	54	☆					
	60	☆		☆			
	64	☆					
	70	☆	☆	☆			
	80	☆	☆				
	90	☆		☆			
	100	☆	☆	☆			

P4 (0.4 mm pitch): With retention fitting



☆: Available for sale

Mated height		1.5mm	2.0mm	2.5mm	3.0mm	3.5mm	4.0mm
Number of contacts	10	☆					
	12	☆					
	20			☆	☆	☆	
	22	☆					
	24		☆				
	28	☆					
	30	☆					
	32			☆			
	34	☆					☆
	40	☆		☆	☆		
	44	☆					
	46	☆					
	50	☆		☆	☆	☆	☆
	60	☆		☆	☆	☆	
	80	☆	☆	☆	☆	☆	☆
	90	☆		☆	☆		
	100	☆					

Note: Please contact us regarding numbers of contacts other than those given above.

AXK7, 8

ORDERING INFORMATION

	AXK							
7: Narrow Pitch Connector P4 (0.4 mm pitch) Socket								
8: Narrow Pitch Connector P4 (0.4 mm pitch) Header								
Number of contacts (2 digits)								
Mated height								
<Socket>								
1: For mated height 1.5 mm								
2: For mated height 2.0 mm								
3: For mated height 2.5 mm and 3.0 mm								
4: For mated height 3.5 mm								
5: For mated height 4.0 mm								
<Header>								
1: For mated height 1.5 mm, 2.0 mm and 2.5 mm								
2: For mated height 3.0 mm, 3.5 mm and 4.0 mm								
Functions								
1: With retention fitting, with positioning bosses								
2: With retention fitting, without positioning bosses								
3: Without retention fitting, with positioning bosses								
4: Without retention fitting, without positioning bosses								
Surface treatment (Contact portion / Terminal portion)								
<Socket>								
5: Ni plating on base, Au plating on surface								
7: Ni plating on base, Au plating on surface (for Ni barrier product available)								
<Header>								
5: Ni plating on base, Au plating on surface								
Other specifications								
<Header>								
Y: V notch type product								
W: V notch and post edge horseshoe bend type product		Note*						
Packing								
G: 3,000 pieces embossed tape and plastic reel × 2*								

Note:
The post edge horseshoe bend indicated by the "W" in the tenth digit of the header part number refers to a construction that makes it difficult for the header post edge to deform when the connector is inserted and removed at an angle.

* Only a socket of mated height 3.5 mm and 4.0 mm: 2,000 pieces embossed tape and plastic reel × 2.

PRODUCT TYPES

1. Without retention fitting **TOUGH CONTACT**

Mated height	Number of contacts	Part number			Packing	
		Socket	Header		Inner carton	Outer carton
		TOUGH CONTACT	TOUGH CONTACT	TOUGH CONTACT and Post edge horseshoe bend type (Recommendation)		
1.5 mm	14	AXK714147G	AXK814145YG	AXK814145WG	3,000 pieces	6,000 pieces
	16	AXK716147G	AXK816145YG	AXK816145WG		
	20	AXK720147G	AXK820145YG	AXK820145WG		
	22	AXK722147G	AXK822145YG	AXK822145WG		
	24	AXK724147G	AXK824145YG	AXK824145WG		
	26	AXK726147G	AXK826145YG	AXK826145WG		
	28	AXK728147G	AXK828145YG	AXK828145WG		
	30	AXK730147G	AXK830145YG	AXK830145WG		
	34	AXK734147G	AXK834145YG	AXK834145WG		
	36	AXK736147G	AXK836145YG	AXK836145WG		
	40	AXK740147G	AXK840145YG	AXK840145WG		
	44	AXK744147G	AXK844145YG	AXK844145WG		
	50	AXK750147G	AXK850145YG	AXK850145WG		
	54	AXK754147G	AXK854145YG	AXK854145WG		
	60	AXK760147G	AXK860145YG	AXK860145WG		
	64	AXK764147G	AXK864145YG	AXK864145WG		
	70	AXK770147G	AXK870145YG	AXK870145WG		
	80	AXK780147G	AXK880145YG	AXK880145WG		
	90	AXK790147G	AXK890145YG	AXK890145WG		
	100	AXK700147G	AXK800145YG	AXK800145WG		
2.0 mm	14	AXK714247G	AXK814145YG	AXK814145WG	3,000 pieces	6,000 pieces
	20	AXK720247G	AXK820145YG	AXK820145WG		
	24	AXK724247G	AXK824145YG	AXK824145WG		
	26	AXK726247G	AXK826145YG	AXK826145WG		
	30	AXK730247G	AXK830145YG	AXK830145WG		
	34	AXK734247G	AXK834145YG	AXK834145WG		
	40	AXK740247G	AXK840145YG	AXK840145WG		
	50	AXK750247G	AXK850145YG	AXK850145WG		
	70	AXK770247G	AXK870145YG	AXK870145WG		
	80	AXK780247G	AXK880145YG	AXK880145WG		
2.5 mm	14	AXK714347G	AXK814145YG	AXK814145WG	3,000 pieces	6,000 pieces
	20	AXK720347G	AXK820145YG	AXK820145WG		
	24	AXK724347G	AXK824145YG	AXK824145WG		
	30	AXK730347G	AXK830145YG	AXK830145WG		
	40	AXK740347G	AXK840145YG	AXK840145WG		
	44	AXK744347G	AXK844145YG	AXK844145WG		
	50	AXK750347G	AXK850145YG	AXK850145WG		
	60	AXK760347G	AXK860145YG	AXK860145WG		
	70	AXK770347G	AXK870145YG	AXK870145WG		
	90	AXK790347G	AXK890145YG	AXK890145WG		
	100	AXK700347G	AXK800145YG	AXK800145WG		

Notes: 1. Regarding ordering units; During production: Please make orders in 1-reel units.

Samples for mounting confirmation: Available in units of 50 pieces. Please consult us. (See "Regarding sample orders to confirm proper mounting" on page 13.)

Samples: Small lot orders are possible.

2. The standard type comes without positioning bosses. Connectors with positioning bosses are available on-demand production. For this type of connector, 8th digit of the part number changes from 4 to 3. e.g. Mated height 1.5 mm and 20 contacts for socket without retention fitting: AXK720137G

3. The 10th digit "Y" in the header part number indicates the connector has V notch. (For details, please refer to page 36.)

"W" indicates a product with V notch and post edge horseshoe bend. ("Post edge horseshoe bend" refers to a construction that makes it difficult for the header post edge to deform when the connector is inserted and removed at an angle.)

"Products with V notch" and "products with V notch and post edge horseshoe bend" are mating compatible.

4. Connectors of different mated height (3.0 mm, 3.5 mm and 4.0 mm) and different number of contacts are available on-demand production only. Please contact us for more details.

SPECIFICATIONS

1. Characteristics

	Item	Specifications	Conditions
Electrical characteristics	Rated current	0.3A/contact (Max. 5 A at total contacts)	
	Rated voltage	60V AC/DC	
	Breakdown voltage	150V AC for 1 min.	Detection current: 1mA
	Insulation resistance	Min. 1,000M Ω (initial)	Using 250V DC megger (applied for 1 min.)
	Contact resistance	Max. 70m Ω	Measured based on the HP4338B measurement method of JIS C 5402
Mechanical characteristics	Composite insertion force	Max. 0.981N {100gf}/contacts $\times$ contacts (initial)	
	Composite removal force	Min. 0.0588N {6gf}/contacts $\times$ contacts (Mated height 1.5 mm, without removal and retention fitting) Min. 0.118N {12gf}/contacts $\times$ contacts (Mated height 1.5 mm, except without removal and retention fitting)	
	Post holding force	Min. 0.981N {100gf}/contacts	Measures the maximum load in the post axial direction until removal
Environmental characteristics	Ambient temperature	-55°C to +85°C	No freezing at low temperatures
	Soldering heat resistance	Max. peak temperature of 245°C	Infrared reflow soldering
		300°C within 5 sec. 350°C within 3 sec.	Soldering iron
	Thermal shock resistance (header and socket mated)	5 cycles, insulation resistance min. 100M Ω , contact resistance max. 70m Ω	Sequence 1. -55 $\pm$ 3°C, 30 minutes 2. ~, Max. 5 minutes 3. 85 $\pm$ 3°C, 30 minutes 4. ~, Max. 5 minutes
	Humidity resistance (header and socket mated)	120 hours, insulation resistance min. 100M Ω , contact resistance max. 70m Ω	Bath temperature 40 $\pm$ 2°C, humidity 90 to 95% R.H.
	Saltwater spray resistance (header and socket mated)	24 hours, insulation resistance min. 100M Ω , contact resistance max. 70m Ω	Bath temperature 35 $\pm$ 2°C, saltwater concentration 5 $\pm$ 1%
Lifetime characteristics	H ₂ S resistance (header and socket mated)	48 hours, contact resistance max. 70m Ω	Bath temperature 40 $\pm$ 2°C, gas concentration 3 $\pm$ 1 ppm, humidity 75 to 80% R.H.
	Insertion and removal life	50 times	Repeated insertion and removal speed of max. 200 times/hours
Unit weight		Mated height 1.5mm, 20 contacts; Socket: 0.04g Header: 0.02g	

2. Material and surface treatment

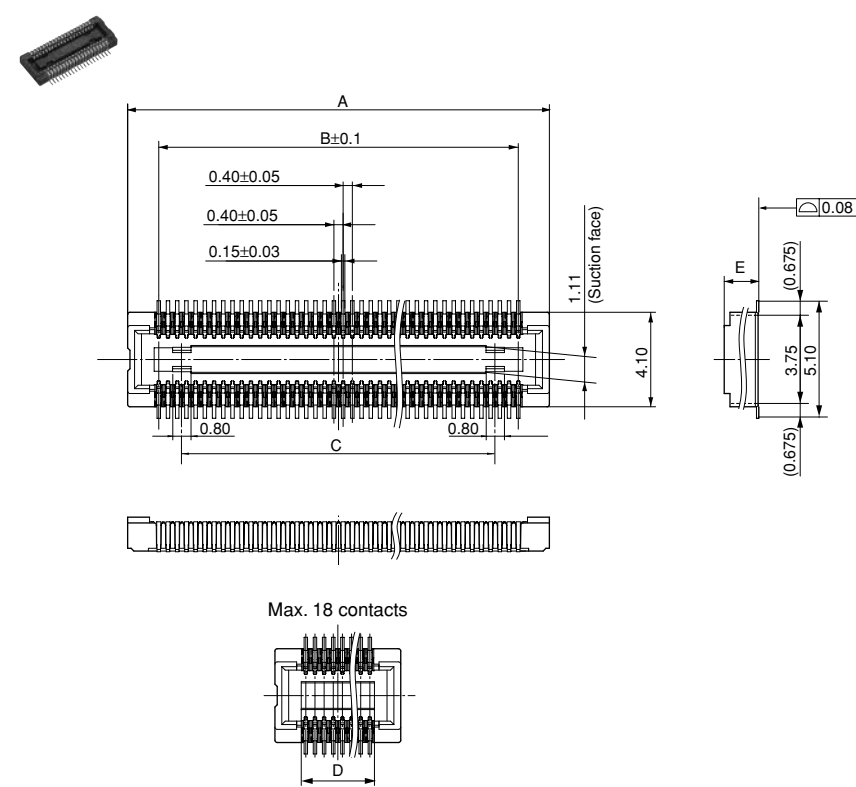
Part name	Material	Surface treatment
Molded portion	Heat-resistant resin (UL94V-0), Black	—
Contact and Post	Copper alloy	Contact portion: Ni plating on base, Au plating on surface Terminal portion: Ni plating on base, Au plating on surface (Except for thick of terminal) However, upper terminal of Ni barrier production: Exposed over Ni The area adjacent to the terminal of the sockets on models with Ni barrier is exposed to Ni on base.
Retention fitting portion	Copper alloy	Ni plating on base, Sn plating on surface (Except for front terminal)

AXK7, 8

DIMENSIONS (mm)

1. Without Retention Fitting

Socket (Mated height: 1.5 mm, 2.0 mm, and 2.5 mm)



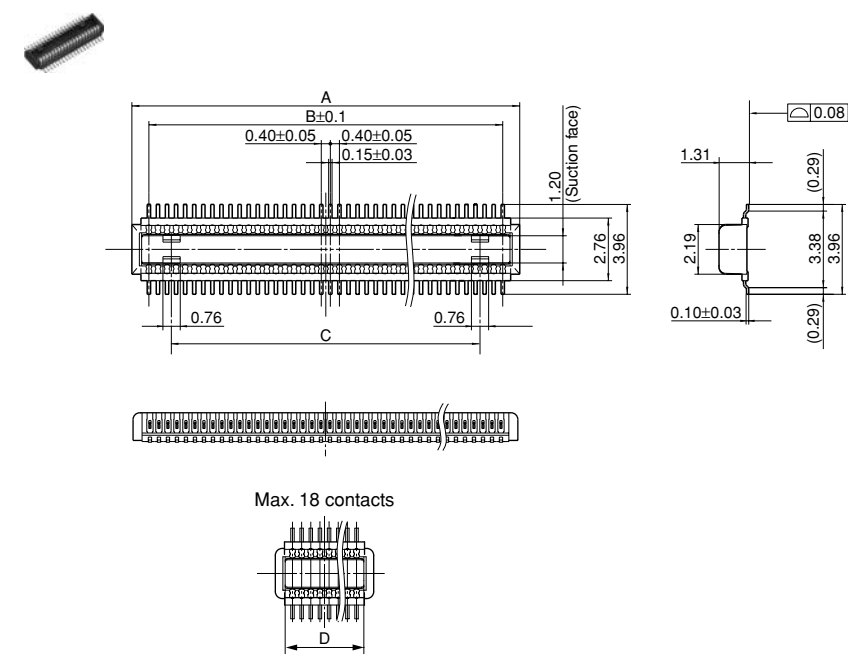
General tolerance: ±0.2

Dimension table (mm)

Number of contacts/ dimension	A	B	C	D
14	5.1	2.4	—	2.8
16	5.5	2.8	—	3.2
20	6.3	3.6	1.6	—
22	6.7	4.0	2.0	—
24	7.1	4.4	2.4	—
26	7.5	4.8	2.8	—
28	7.9	5.2	3.2	—
30	8.3	5.6	3.6	—
34	9.1	6.4	4.4	—
36	9.5	6.8	4.8	—
40	10.3	7.6	5.6	—
44	11.1	8.4	6.4	—
50	12.3	9.6	7.6	—
54	13.1	10.4	8.4	—
60	14.3	11.6	9.6	—
64	15.1	12.4	10.4	—
70	16.3	13.6	11.6	—
80	18.3	15.6	13.6	—
90	20.3	17.6	15.6	—
100	22.3	19.6	17.6	—

Mated height/dimension	E
1.5mm	1.50
2.0mm	1.92
2.5mm	2.42

Header (Mated height: 1.5 mm, 2.0 mm, and 2.5 mm “products with V notch”)

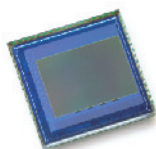


General tolerance: ±0.2

Dimension table (mm)

Number of contacts/ dimension	A	B	C	D
14	3.9	2.4	—	3.04
16	4.3	2.8	—	3.44
20	5.1	3.6	1.6	—
22	5.5	4.0	2.0	—
24	5.9	4.4	2.4	—
26	6.3	4.8	2.8	—
28	6.7	5.2	3.2	—
30	7.1	5.6	3.6	—
34	7.9	6.4	4.4	—
36	8.3	6.8	4.8	—
40	9.1	7.6	5.6	—
44	9.9	8.4	6.4	—
50	11.1	9.6	7.6	—
54	11.9	10.4	8.4	—
60	13.1	11.6	9.6	—
64	13.9	12.4	10.4	—
70	15.1	13.6	11.6	—
80	17.1	15.6	13.6	—
90	19.1	17.6	15.6	—
100	21.1	19.6	17.6	—

Note: “Products with V notch” and “products with V notch and post edge horseshoe bend” are mating compatible.



OV5640 5-megapixel product brief



available in
a lead-free
package

1/4-inch, 5-Megapixel SOC Image Sensor Optimized for High-Volume Mobile Markets

The OV5640 delivers a complete 5-megapixel camera solution on a single chip, aimed at offering cost efficiencies that serve the high-volume autofocus (AF) camera phone market. The system-on-a-chip (SOC) sensor features OmniVision's 1.4 micron OmniBSI™ backside illumination architecture to deliver excellent pixel performance and best-in-class low-light sensitivity, while enabling ultra compact camera module designs of 8.5 mm x 8.5 mm with <6 mm z-height. The OV5640 provides the full functionality of a complete camera, including anti-shake technology, AF control, and MIPI while being easier to tune than two-chip solutions, making it an ideal choice in terms of cost, time-to-market and ease of platform integration.

The OV5640 enables 720p HD video at 60 frames per second (fps) and 1080p HD video at 30 fps with complete user control over formatting and output data transfer. The 720p/60 HD video is captured in full field of view (FOV) with 2 x 2 binning, which doubles the sensitivity and improves the signal-to-noise ratio (SNR). Additionally, a unique post-binning re-sampling filter function removes zigzag artifacts around slant edges and minimizes spatial artifacts to deliver even sharper, crisper

color images. To further improve camera performance and user experience, the OV5640 features an internal anti-shake engine for image stabilization, and it supports Scalado™ tagging for faster image preview and zoom.

The OV5640 offers a digital video port (DVP) parallel interface and a high-speed dual lane MIPI interface, supporting multiple output formats. An integrated JPEG compression engine simplifies data transfer for bandwidth-limited interfaces. The sensor's automatic image control functions include automatic exposure control (AEC), automatic white balance (AWB), automatic band filter (ABF), 50/60 Hz automatic luminance detection, and automatic black level calibration (ABLC). The OV5640 delivers programmable controls for frame rate, AEC/AGC 16-zone size/position/weight control, mirror and flip, cropping, windowing, and panning. It also offers color saturation, hue, gamma, sharpness (edge enhancement), lens correction, defective pixel canceling, and noise canceling to improve image quality.

Find out more at www.ovt.com.

applications

- cellular phones
- toys
- PC multimedia
- digital still cameras

ordering information

- **OV05640-A71A-1B** (color, lead-free)
71-pin CSP

features

- 1.4 μm x 1.4 μm pixel with OmniBSI technology for high performance (high sensitivity, low crosstalk, low noise, improved quantum efficiency)
- optical size of 1/4"
- automatic image control functions: automatic exposure control (AEC), automatic white balance (AWB), automatic band filter (ABF), automatic 50/60 Hz luminance detection, and automatic black level calibration (ABLC)
- programmable controls for frame rate, AEC/AGC 16-zone size/position/weight control, mirror and flip, cropping, windowing, and panning
- image quality controls: color saturation, hue, gamma, sharpness (edge enhancement), lens correction, defective pixel canceling, and noise canceling
- support for output formats: RAW RGB, RGB565/555/444, CCIR656, YUV422/420, YCbCr422, and compression
- support for video or snapshot operations
- support for internal and external frame synchronization for frame exposure mode
- support for LED and flash strobe mode
- support for horizontal and vertical sub-sampling, binning
- support for minimizing artifacts on binned image
- support for data compression output
- support for anti-shake
- standard serial SCCB interface
- digital video port (DVP) parallel output interface and dual lane MIPI output interface
- embedded 1.5V regulator for core power
- programmable I/O drive capability, I/O tri-state configurability
- support for black sun cancellation
- support for images sizes: 5 megapixel, and any arbitrary size scaling down from 5 megapixel
- support for auto focus control (AFC) with embedded AF VCM driver
- embedded microcontroller
- suitable for module size of 8.5 x 8.5 x <6mm with both CSP and RW packaging

key specifications (typical)

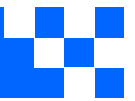
- **active array size:** 2592 x 1944
- **power supply:**
 - core: 1.425 ~ 1.675V (with embedded 1.5V regulator)
 - analog: 2.6 ~ 3.0V (2.8V typical)
 - I/O: 1.8V / 2.8V
- **power requirements:**
 - active: 140 mA
 - standby: 20 μA
- **temperature range:**
 - operating: -30°C to 70°C junction temperature (see [table 8-2](#))
 - stable image: 0°C to 50°C junction temperature (see [table 8-2](#))
- **output formats:** 8-/10-bit RGB RAW output
- **lens size:** 1/4"
- **lens chief ray angle:** 24° (see [figure 10-2](#))
- **input clock frequency:** 6~27 MHz
- **max S/N ratio:** 36 dB
- **dynamic range:** 68 dB @ 8x gain
- **maximum image transfer rate:**
 - QSXGA (2592x1944): 15 fps
 - 1080p: 30 fps
 - 1280x960: 45 fps
 - 720p: 60 fps
 - VGA (640x480): 90 fps
- **sensitivity:** 600 mV/Lux-sec
- **shutter:** rolling shutter / frame exposure
- **maximum exposure interval:** 1964 x t_{ROW}
- **pixel size:** 1.4 μm x 1.4 μm
- **dark current:** 8 mV/s @ 60°C junction temperature
- **image area:** 3673.6 μm x 2738.4 μm
- **package dimensions:** 5985 μm x 5835 μm

Camera Module Pinout Definition Reference Chart

OmniVision Sony Samsung On-Semi Aptina Himax GalaxyCore PixArt SmartSens Sensors	
Pin Signal	Description
DGND GND	ground for digital circuit
AGND	ground for analog circuit
PCLK DCK	DVP PCLK output
XCLR PWDN XSHUTDOWN STANDBY	power down active high with internal pull-down resistor
MCLK XVCLK XCLK INCK	system input clock
RESET RST	reset active low with internal pull-up resistor
NC NULL	no connect
SDA SIO_D SIOD	SCCB data
SCL SIO_C SIOC	SCCB input clock
VSYNC XVS FSYNC	DVP VSYNC output
HREF XHS	DVP HREF output
DOVDD	power for I/O circuit
AFVDD	power for VCM circuit
AVDD	power for analog circuit
DVDD	power for digital circuit
STROBE FSTROBE	strobe output
FSIN	synchronize the VSYNC signal from the other sensor
SID	SCCB last bit ID input
ILPWM	mechanical shutter output indicator
FREX	frame exposure / mechanical shutter
GPIO	general purpose inputs
SLASEL	I2C slave address select
AFEN	CEN chip enable active high on VCM driver IC
MIPI Interface	
MDN0 DN0 MD0N DATA_N DMO1N	MIPI 1st data lane negative output
MDP0 DP0 MD0P DATA_P DMO1P	MIPI 1st data lane positive output
MDN1 DN1 MD1N DATA2_N DMO2N	MIPI 2nd data lane negative output
MDP1 DP1 MD1P DATA2_P DMO2P	MIPI 2nd data lane positive output
MDN2 DN2 MD2N DATA3_N DMO3N	MIPI 3rd data lane negative output
MDP2 DP2 MD2P DATA3_P DMO3P	MIPI 3rd data lane positive output
MDN3 DN3 MD3N DATA4_N DMO4N	MIPI 4th data lane negative output
MDP3 DP3 MD3P DATA4_P DMO4P	MIPI 4th data lane positive output
MCN CLKN CLK_N DCKN	MIPI clock negative output
MCP CLKP MCP CLK_P DCKN	MIPI clock positive output
DVP Parallel Interface	
D0 DO0 Y0	DVP data output port 0
D1 DO1 Y1	DVP data output port 1
D2 DO2 Y2	DVP data output port 2
D3 DO3 Y3	DVP data output port 3
D4 DO4 Y4	DVP data output port 4
D5 DO5 Y5	DVP data output port 5
D6 DO6 Y6	DVP data output port 6
D7 DO7 Y7	DVP data output port 7
D8 DO8 Y8	DVP data output port 8
D9 DO9 Y9	DVP data output port 9
D10 DO10 Y10	DVP data output port 10
D11 DO11 Y11	DVP data output port 11

Referenztabelle für die Pinbelegungsdefinition des Kameramoduls

OmniVision Sony Himax Samsung On-Semi Aptina Himax GalaxyCore PixArt Bildsensoren	
Pin Signal	Beschreibung
DGND GND	Masse für digitale Schaltung
AGND	Masse für analoge Schaltung
PCLK DCK	DVP-PCLK-Ausgang
XCLR PWDN XSHUTDOWN STANDBY	Abschalten aktiv hoch mit internem Pulldown-Widerstand
MCLK XVCLK XCLK INCK	Systemeingangsuhr
RESET RST	Aktiv Low mit internem Pull-up-Widerstand zurücksetzen
NC NULL	keine Verbindung
SDA SIO_D SIOD	SCCB-Daten
SCL SIO_C SOIC	SCCB-Eingangstakt
VSYNCS XVS FSYNCS	DVP-VSYNCS-Ausgang
HREF XHS	DVP-HREF-Ausgang
DOVDD	Strom für E/A-Schaltung
AFVDD	Strom für VCM-Schaltung
AVDD	Strom für analoge Schaltung
DVDD	Strom für digitale Schaltung
STROBE FSTROBE	Strobe-Ausgang
FSIN	Synchronisieren Sie das VSYNCS-Signal vom anderen Sensor
SID	SCCB letzte Bit-ID-Eingabe
ILPWM	mechanische Shutter-Ausgangsanzeige
FREX	Rahmenbelichtung / mechanischer Verschluss
GPIO	Allzweckeingänge
SLASEL	I2C-Slave-Adresse auswählen
AFEN	CEN-Chip aktivieren aktiv hoch auf VCM-Treiber-IC
MIPI Schnittstelle	
MDN0 DN0 MD0N DATA_N DMO1N	MIPI 1st negative Ausgabe der Datenspur
MDP0 DP0 MD0P DATA_P DMO1P	MIPI 1st positiver Ausgang der Datenspur
MDN1 DN1 MD1N DATA2_N DMO2N	MIPI 2nd negative Ausgabe der Datenspur
MDP1 DP1 MD1P DATA2_P DMO2P	MIPI 2nd positiver Ausgang der Datenspur
MDN2 DN2 MD2N DATA3_N DMO3N	MIPI 3rd negative Ausgabe der Datenspur
MDP2 DP2 MD2P DATA3_P DMO3P	MIPI 3rd positiver Ausgang der Datenspur
MDN3 DN3 MD3N DATA4_N DMO4N	MIPI 4th negative Ausgabe der Datenspur
MDP3 DP3 MD3P DATA4_P DMO4P	MIPI 4th positiver Ausgang der Datenspur
MCN CLKN CLK_N DCKN	MIPI Uhr negativer Ausgang
MCP CLKP MCP CLK_P DCKN	MIPI Takt positiver Ausgang
DVP Parallel Schnittstelle	
D0 DO0 Y0	DVP Datenausgabeport 0
D1 DO1 Y1	DVP Datenausgabeport 1
D2 DO2 Y2	DVP Datenausgabeport 2
D3 DO3 Y3	DVP Datenausgabeport 3
D4 DO4 Y4	DVP Datenausgabeport 4
D5 DO5 Y5	DVP Datenausgabeport 5
D6 DO6 Y6	DVP Datenausgabeport 6
D7 DO7 Y7	DVP Datenausgabeport 7
D8 DO8 Y8	DVP Datenausgabeport 8
D9 DO9 Y9	DVP Datenausgabeport 9
D10 DO10 Y10	DVP Datenausgabeport 10
D11 DO11 Y11	DVP Datenausgabeport 11



Kameraanwendungen

your BEST camera module partner



IMAGING DEVICES



Kamera-Zuverlässigkeitstest

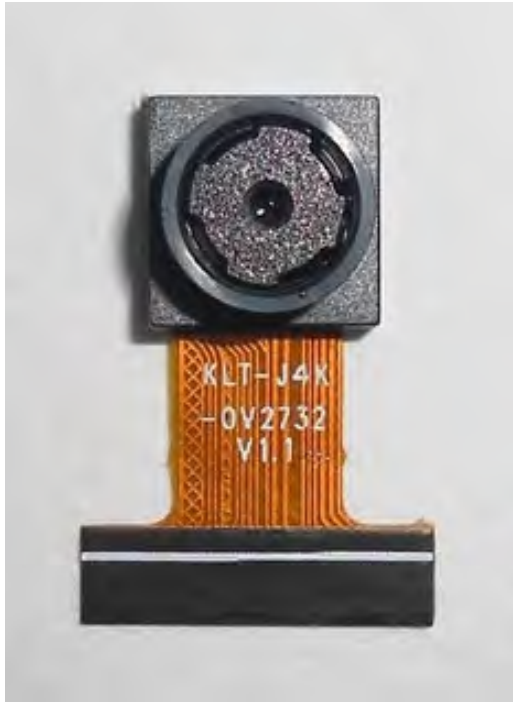
Reliability Inspection Item			Testmethode	Akzeptanzkriterium
Kategorie		Artikel		
Umwelt	Lager Temperatur	Hoch 60°C 96 Std	Temperaturkammer	Keine anormale Situation
		Niedrig -20°C 96 Std	Temperaturkammer	Keine anormale Situation
	Betriebs Temperatur	Hoch 60°C 24 Std	Temperaturkammer	Keine anormale Situation
		Niedrig -20°C 24 Std	Temperaturkammer	Keine anormale Situation
	Feuchtigkeit	60°C 80% 24 Std	Temperaturkammer	Keine anormale Situation
	Thermischer Schock	Hoch 60°C 0.5 Std Niedrig -20°C 0.5 Std Radfahren rein 24 Std	Temperaturkammer	Keine anormale Situation
Physisch	Falltest (Im freien Fall)	Ohne Verpackung 60cm	10 Mal auf Holzboden	Elektrisch funktionsfähig
		Mit Paket 60cm	10 Mal auf Holzboden	Elektrisch funktionsfähig
	Vibrations Test	50Hz X-Axis 2mm 30 Minuten	Vibrationstisch	Elektrisch funktionsfähig
		50Hz Y-Axis 2mm 30 Minuten	Vibrationstisch	Elektrisch funktionsfähig
		50Hz Z-Axis 2mm 30 Minuten	Vibrationstisch	Elektrisch funktionsfähig
	Zugfestigkeit des Kabels Krafttest	Gewicht laden 4 kg 60 Sekunden Radfahren rein 24 Std	Zugprüfmaschine	Elektrisch funktionsfähig
Elektrisch	ESD-Test	Kontaktaufnahme 2 KV	ESD-Prüfmaschine	Elektrisch funktionsfähig
		Luftentladung 4 KV	ESD-Prüfmaschine	Elektrisch funktionsfähig
	Alterungstest	On/Off 30 Sekunden Radfahren rein 24 Std	Stromschalter	Elektrisch funktionsfähig
	USB-Anschluss	On/Off 250 Mal	Einstecken und ausstecken	Elektrisch funktionsfähig



Inspektionsgegenstand		Untersuchungsmethode	Inspektionsstandard		
Kategorie	Artikel				
Aussehen	FPC oder PCB	Farbe	Das bloße Auge	Größere Unterschiede sind nicht zulässig.	
		Zerrissen/gehackt werden	Das bloße Auge	Das Freilegen von Kupferrissen ist nicht zulässig.	
		Markierung	Das bloße Auge	Klar, erkennbar (innerhalb von 30 cm Entfernung)	
	Halterin	Kratzer	Das bloße Auge	Die Freilegung von Rissen im Inneren ist nicht zulässig	
		Lücke	Das bloße Auge	Erfüllen Sie den Höhenstandard	
		Schraube	Das bloße Auge	Stellen Sie sicher, dass Schrauben vorhanden sind (falls vorhanden)	
		Schaden	Das bloße Auge	Die Freilegung von Rissen im Inneren ist nicht zulässig	
	Linse	Kratzen	Das bloße Auge	Keine Auswirkung auf den Auflösungsstandard	
		Kontamination	Das bloße Auge	Keine Auswirkung auf den Auflösungsstandard	
		Ölfilm	Das bloße Auge	Keine Auswirkung auf den Auflösungsstandard	
		Abdeckband	Das bloße Auge	Kein Problem beim Aussehen.	
	Funktion	Bild	Keine Kommunikation	Testboard	Nicht erlaubt
Helles Pixel			Tafel	Im Image Center nicht erlaubt	
Dunkles Pixel			Weißer Tafel	Im Image Center nicht erlaubt	
Verschwommen			Das bloße Auge	Nicht erlaubt	
Kein Bild			Das bloße Auge	Nicht erlaubt	
Vertikale Linie			Das bloße Auge	Nicht erlaubt	
Horizontale Linie			Das bloße Auge	Nicht erlaubt	
Kleines Leck			Das bloße Auge	Nicht erlaubt	
Blinkendes Bild			Das bloße Auge	Nicht erlaubt	
Prellung			Inspektionslehre	Nicht erlaubt	
Auflösung			Diagramm	Folgt dem Diagrammstandard für ausgehende Inspektionen	
Farbe			Das bloße Auge	Kein Problem	
Lärm			Das bloße Auge	Nicht erlaubt	
Ecke dunkel			Das bloße Auge	Weniger als 100 x 100 Pixel	
Farbauflösung			Das bloße Auge	Kein Problem	
Abmessungen			Höhe	Das bloße Auge	Befolgt Zulassungsdatenblatt
			Breite	Das bloße Auge	Befolgt Zulassungsdatenblatt
	Länge	Das bloße Auge	Befolgt Zulassungsdatenblatt		
	Gesamt	Das bloße Auge	Befolgt Zulassungsdatenblatt		

KLT-Paketlösungen

KLT Kameramodul



Komplett mit Linsenschutzfolie



Tablett mit Gitter und Raum

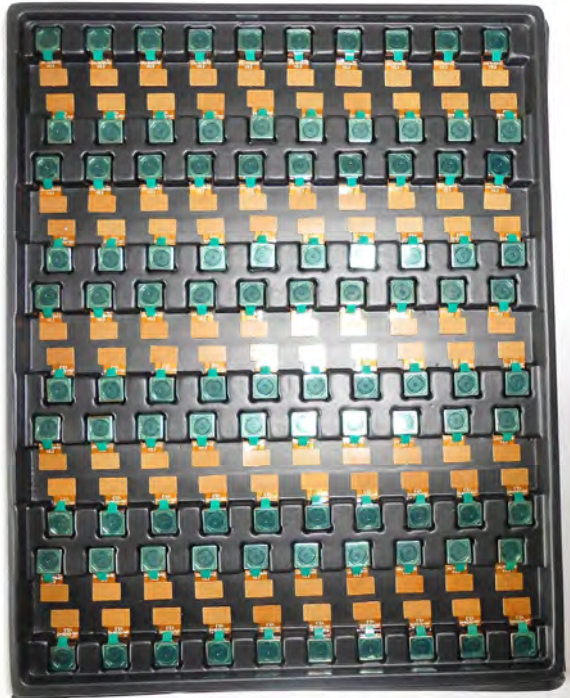


Legen Sie die Kameras auf das Tablett



Paketlösung für Kameramodule

Volles Tablett mit Kameras



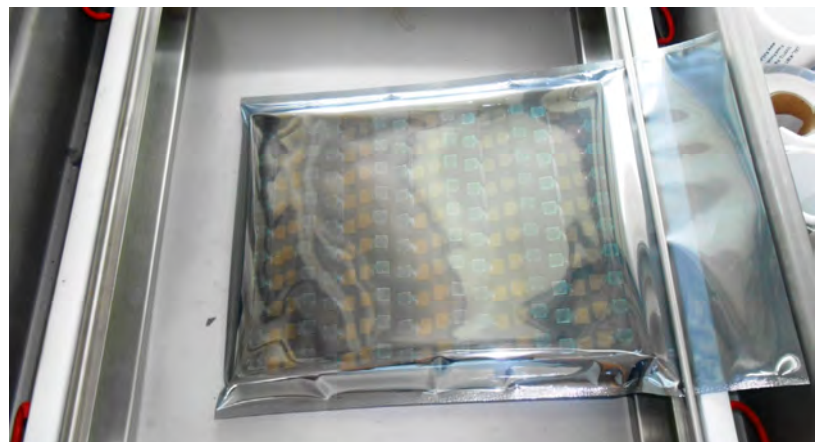
Abdeckschale mit Deckel



In Antistatikbeutel stecken



Staubsaugen Sie den antistatischen Beutel



Paketlösung für Kameramodule

Versiegelter Vakuumbbeutel mit Etiketten

1. Modell und Beschreibung 2. Menge 3. Versanddatum 4. Achtung



Paketlösung für große Bestellungen

Schaumstoffplatten zwischen
die Tablettts legen



Schaumstoffplatten sind etwas
größer als Tablettts



Legen Sie Schaumstoffplatten und
Tablettts in die Schachtel



Schaumstoffplatten sind eng anliegende Box



Paketlösung für kleine Bestellungen

Legen Sie die Schaumstoffplatten und
Tablets in die kleine Schachtel



Schaumstoffplatten passen gut in
die kleine Box



Paket in kleiner Box für den Versand



Legen Sie kleine Kartons in größere Kartons



Carbon Box Paketlösung

Verschließen Sie die Carbonbox

Beschriftete Schachtel mit Endverpackung



Versandfertige Karbonbox

1. Lieferadresse und Telefonnummer
2. Box-Nr. und Versanddatum
3. Zerbrechliche Vorsicht



Lösung für Musterbestellungspakete

Legen Sie die Probe in einen kleinen antistatischen Beutel



Stecken Sie die Anschlüsse in den kleinen antistatischen Beutel



Musteretiketten auf dem kleinen Beutel

1. Kameramodul oder Anschlussmodell 2. Lieferdatum und Menge 3. Achtung



Steckverbinder Paketlösung für große Bestellungen

Steckverbinder in einem Rad



Steckverbinder im Rad beschriften



Das Rad passt perfekt in die Box



Steckerbox versandfertig

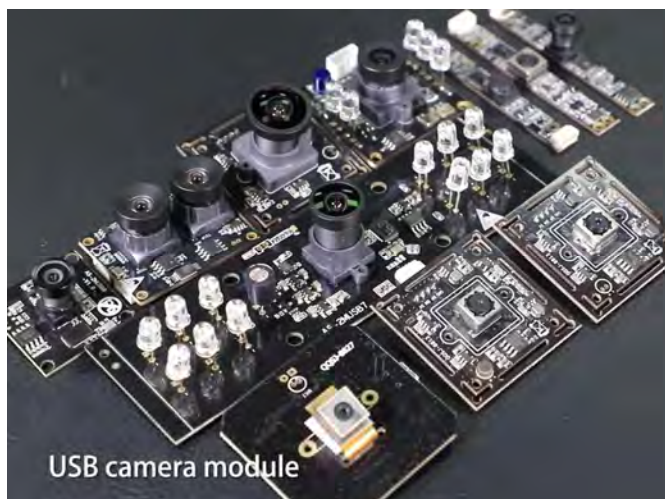


Unternehmen Kai Lap Technologies (KLT)

Kai Lap Technologies Group Limited. (KLT) wurde 2009 gegründet und ist ein technologiegetriebener Hersteller der nächsten Generation, der sich auf Forschung, Design und Produktion von Audio- und Videoprodukten spezialisiert hat. KLT verfügt über 20.000 Quadratfuß automatisierte Fabriken mit 100 Mitarbeitern und einem jährlichen Durchsatz von 30.000.000 Kameraeinheiten.

KLT bietet OEM-, ODM-Design, Auftragsfertigung und baut die Kameraprodukte. Sie können uns die Anforderungen auch mit einem Handentwurf übermitteln, unser Vertrieb und unsere Technik arbeiten zusammen, um Ihre Anforderungen zu erfüllen. Wir verstehen uns als Ihr langfristiger Partner bei der Entwicklung praktischer und innovativer Lösungen.

Unser Team deckt alles von der ersten Konzeptentwicklung bis zum Massenprodukt ab. KLT ist spezialisiert auf kundenspezifisches Kameradesign, Rohmaterial, Elektrotechnik, Firmware-/Softwareentwicklung, Produkttests und Verpackungsdesign. Unsere erfahrenen strategischen Versorgungssysteme bieten eine robuste und zuverlässige Fertigungskapazität für Aufträge unterschiedlicher Größe.

**Eingeschränkte Garantie**

KLT gewährt die folgende eingeschränkte Garantie, wenn Sie das/die Produkt(e) direkt von der Firma KLT oder von der Website von KLT, www.KaiLapTech.com, gekauft haben. Produkte, die von anderen Verkäufern oder Quellen gekauft wurden, fallen nicht unter diese beschränkte Garantie. KLT garantiert, dass das/die Produkt(e) bei normalem Gebrauch für einen Zeitraum von einem (1) Jahr ab dem Datum, an dem Sie das Produkt erhalten („Garantiezeitraum“), frei von Material- und Verarbeitungsfehlern sind.

Für alle Produkte, die während des Garantiezeitraums Material- oder Verarbeitungsfehler enthalten oder entwickeln, wird KLT nach eigenem Ermessen entweder: (i) die Produkte reparieren; (ii) das/die Produkt(e) durch ein neues oder generalüberholtes Produkt(e) ersetzen (Ersatzprodukt(e) sind von identischem Modell oder funktionell gleichwertig); oder (iii) Ihnen den Preis erstatten, den Sie für das/die Produkt(e) gezahlt haben.

Diese eingeschränkte Garantie von KLT ist ausschließlich auf Reparatur und/oder Ersatz zu den oben genannten Bedingungen beschränkt. KLT ist nicht zuverlässig oder verantwortlich für nachfolgende Ereignisse.

